

High Voltage IGBT with optional Diode

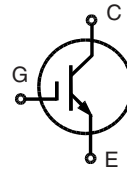
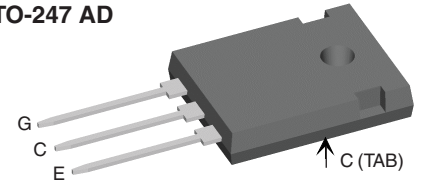
Short Circuit SOA Capability
Square RBSOA

$$V_{CES} = 1200 \text{ V}$$

$$I_{C25} = 60 \text{ A}$$

$$V_{CE(sat) \text{ typ}} = 2.4 \text{ V}$$

Type	Replacements
IXDH30N120	IXDH30N120D1 IXA33IF1200HB


TO-247 AD


G = Gate,
C = Collector ,
E = Emitter
TAB = Collector

Symbol	Conditions	Maximum Ratings	
V_{CES}	$T_J = 25^\circ\text{C}$ to 150°C	1200	V
V_{CGR}	$T_J = 25^\circ\text{C}$ to 150°C ; $R_{GE} = 20 \text{ k}\Omega$	1200	V
V_{GES}	Continuous	± 20	V
V_{GEM}	Transient	± 30	V
I_{C25}	$T_C = 25^\circ\text{C}$	60	A
I_{C90}	$T_C = 90^\circ\text{C}$	38	A
I_{CM}	$T_C = 90^\circ\text{C}$; $t_p = 1 \text{ ms}$	76	A
RBSOA	$V_{GE} = \pm 15 \text{ V}$; $T_J = 125^\circ\text{C}$; $R_G = 47 \Omega$ Clamped inductive load; $L = 30 \mu\text{H}$	$I_{CM} = 50$ $V_{CEK} < V_{CES}$	A
t_{SC} (SCSOA)	$V_{GE} = \pm 15 \text{ V}$; $V_{CE} = V_{CES}$; $T_J = 125^\circ\text{C}$ $R_G = 47 \Omega$, non repetitive	10	μs
P_C	$T_C = 25^\circ\text{C}$; IGBT	300	W
	Diode	135	W
T_J		-55 ... +150	$^\circ\text{C}$
T_{stg}		-40 ... +150	$^\circ\text{C}$
M_d	Mounting torque	1.1/10	Nm/lb.in.
Weight		6	g

Features

- NPT IGBT technology
- low saturation voltage
- low switching losses
- square RBSOA, no latch up
- high short circuit capability
- positive temperature coefficient for easy paralleling
- MOS input, voltage controlled
- optional ultra fast diode
- International standard packages

Advantages

- Space savings
- High power density
- IXDT: surface mountable high power package

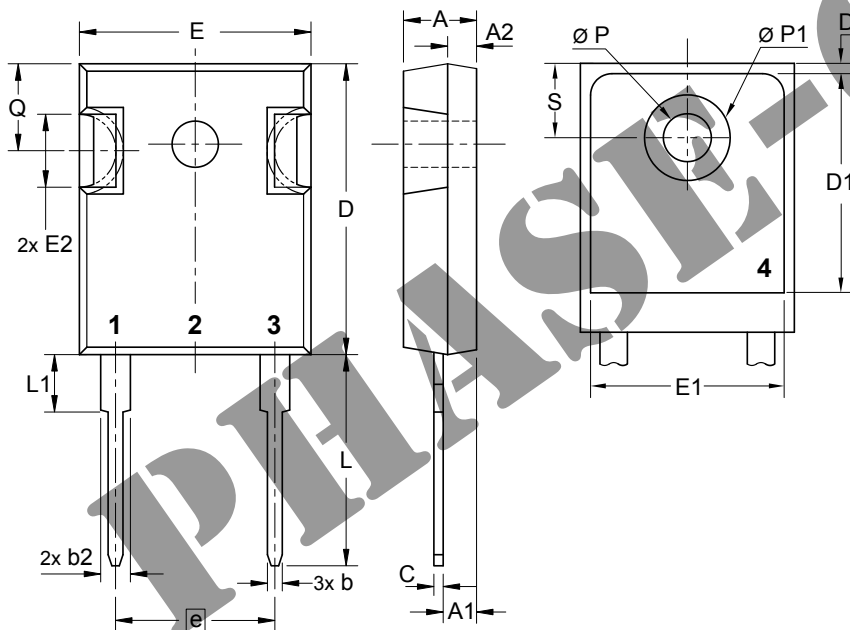
Typical Applications

- AC motor speed control
- DC servo and robot drives
- DC choppers
- Uninterruptible power supplies (UPS)
- Switch-mode and resonant-mode power supplies

Symbol	Conditions	Characteristic Values ($T_J = 25^\circ\text{C}$, unless otherwise specified)		
		min.	typ.	max.
$V_{(BR)CES}$	$V_{GE} = 0 \text{ V}$	1200		V
$V_{GE(th)}$	$I_C = 1 \text{ mA}$; $V_{CE} = V_{GE}$	4.5		V
I_{CES}	$V_{CE} = V_{CES}$; $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$		2.5	1.5 mA mA
I_{GES}	$V_{CE} = 0 \text{ V}$; $V_{GE} = \pm 20 \text{ V}$			$\pm 500 \text{ nA}$
$V_{CE(sat)}$	$I_C = 30 \text{ A}$; $V_{GE} = 15 \text{ V}$	2.4	2.9	V

Symbol	Conditions	Characteristic Values		
		(T _J = 25°C, unless otherwise specified)		
		min.	typ.	max.
C _{ies}	V _{CE} = 25 V; V _{GE} = 0 V; f = 1 MHz		1650	pF
C _{oes}			250	pF
C _{res}			110	pF
Q _g	I _C = 30 A; V _{GE} = 15 V; V _{CE} = 0.5 V _{CES}		120	nC
t _{d(on)}	Inductive load, T _J = 125°C I _C = 30 A; V _{GE} = ±15 V; V _{CE} = 600 V; R _G = 47 Ω		100	ns
t _r			70	ns
t _{d(off)}			500	ns
t _f			70	ns
E _{on}			4.6	mJ
E _{off}			3.4	mJ
R _{thJC}	Package with heatsink compound			0.42 K/W
R _{thCK}			0.25	K/W

Symbol	Conditions	Characteristic Values		
		(T _J = 25°C, unless otherwise specified)		
		min.	typ.	max.
V _F	I _F = 30 A; V _{GE} = 0 V		2.5	2.7 V
	I _F = 30 A; V _{GE} = 0 V; T _J = 125°C		2.0	V
I _F	T _C = 25°C			60 A
	T _C = 90°C			35 A
I _{RM}	I _F = 30 A; -di _F /dt = 400 A/μs; V _R = 600 V		20	A
t _{rr}	V _{GE} = 0 V; T _J = 125°C		200	ns
t _{rr}	I _F = 1 A; -di _F /dt = 100 A/μs; V _R = 30 V; V _{GE} = 0 V		40	ns
R _{thJC}				1 K/W

TO-247 AD Outline


Sym.	Inches		Millimeter	
	min.	max.	min.	max.
A	0.185	0.209	4.70	5.30
A1	0.087	0.102	2.21	2.59
A2	0.059	0.098	1.50	2.49
D	0.819	0.845	20.79	21.45
E	0.610	0.640	15.48	16.24
E2	0.170	0.216	4.31	5.48
e	0.430 BSC		10.92 BSC	
L	0.780	0.800	19.80	20.30
L1	-	0.177	-	4.49
Ø P	0.140	0.144	3.55	3.65
Q	0.212	0.244	5.38	6.19
S	0.242 BSC		6.14 BSC	
b	0.039	0.055	0.99	1.40
b2	0.065	0.094	1.65	2.39
b4	0.102	0.135	2.59	3.43
c	0.015	0.035	0.38	0.89
D1	0.515	-	13.07	-
D2	0.020	0.053	0.51	1.35
E1	0.530	-	13.45	-
Ø P1	-	0.29	-	7.39

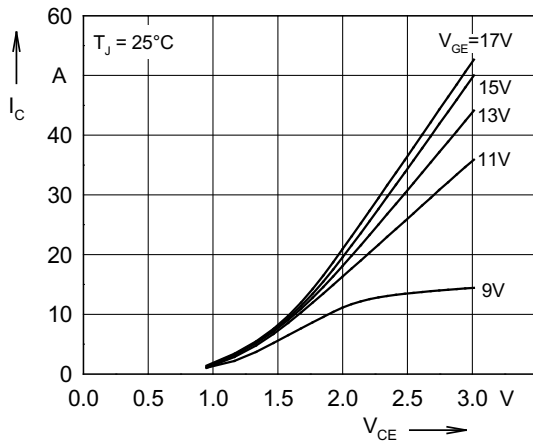


Fig. 1 Typ. output characteristics

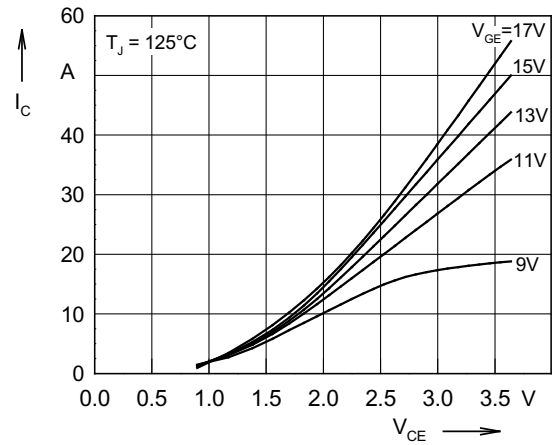


Fig. 2 Typ. output characteristics

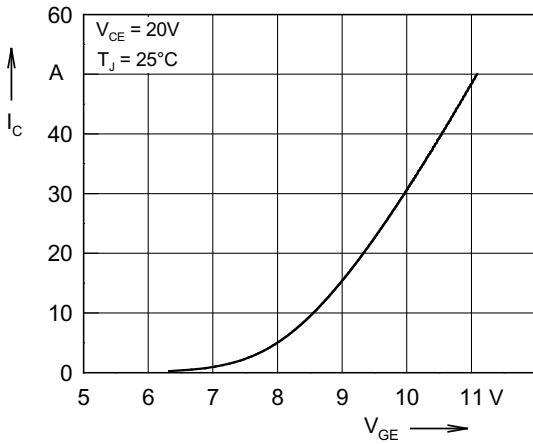


Fig. 3 Typ. transfer characteristics

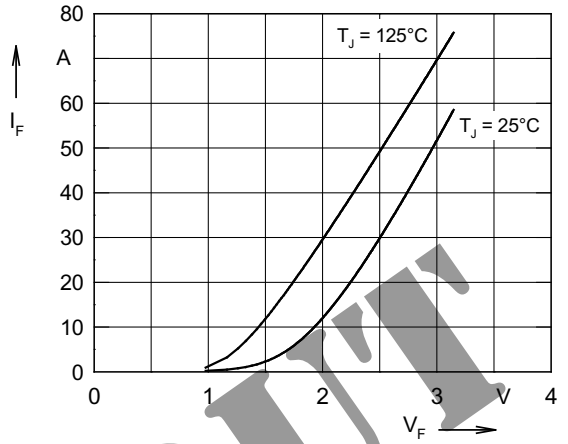


Fig. 4 Typ. forward characteristics of free wheeling diode

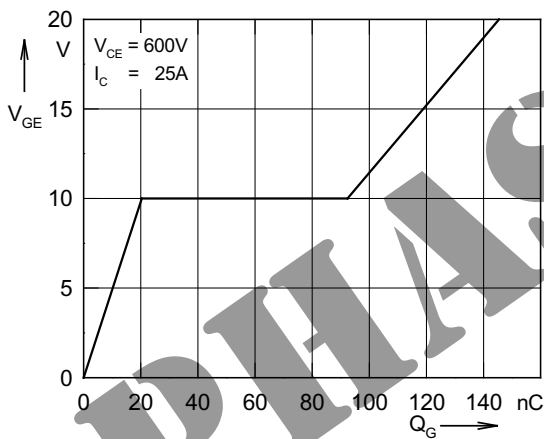


Fig. 5 Typ. turn on gate charge

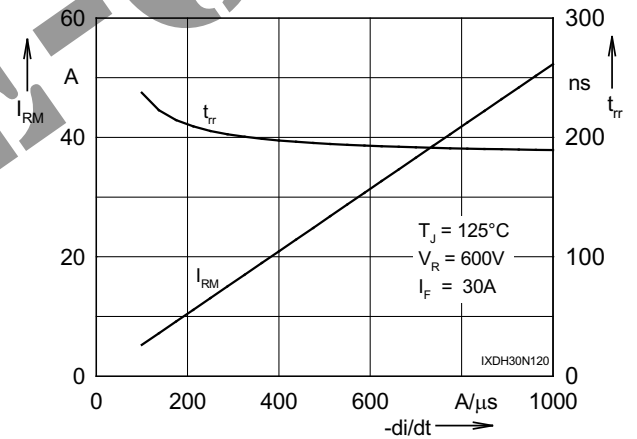


Fig. 6 Typ. turn off characteristics of free wheeling diode

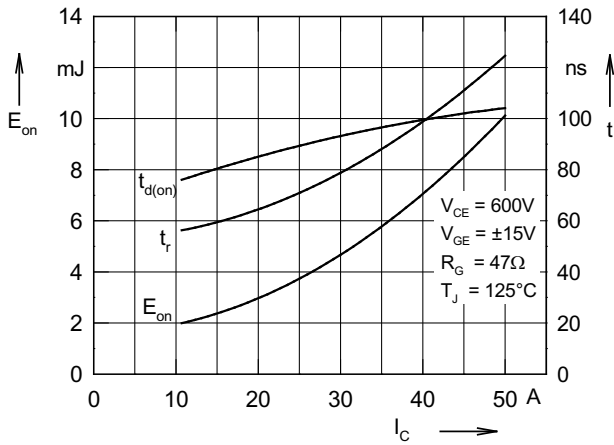


Fig. 7 Typ. turn on energy and switching times versus collector current

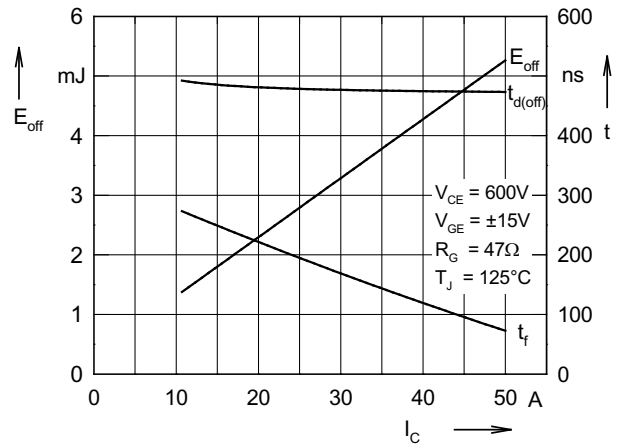


Fig. 8 Typ. turn off energy and switching times versus collector current

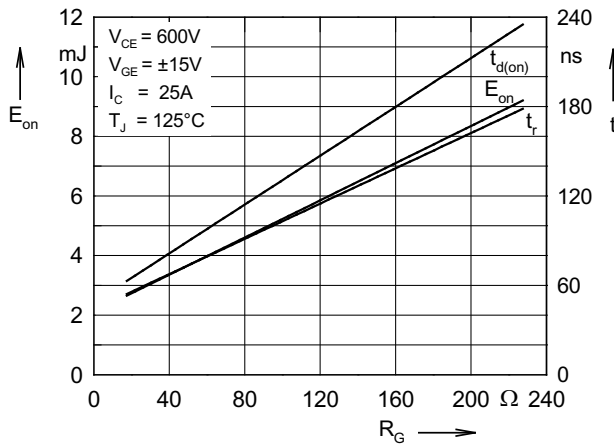


Fig. 9 Typ. turn on energy and switching times versus gate resistor

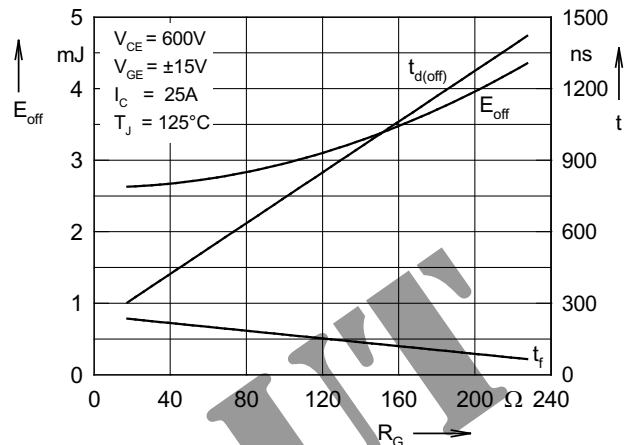


Fig. 10 Typ. turn off energy and switching times versus gate resistor

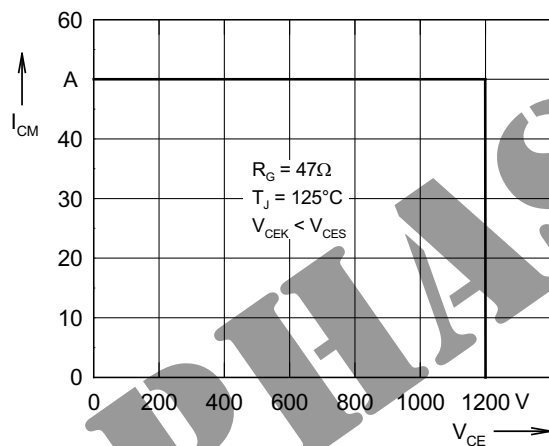


Fig. 11 Reverse biased safe operating area RBSOA

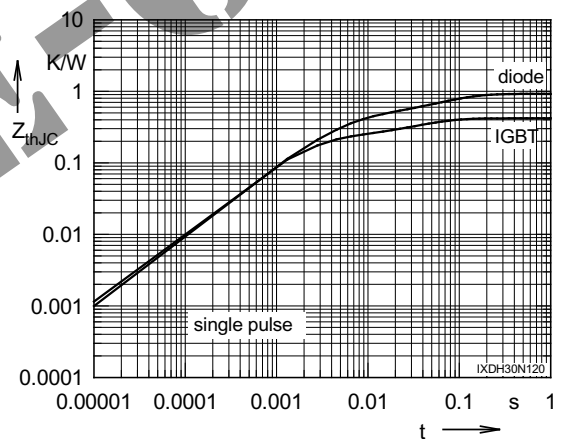


Fig. 12 Typ. transient thermal impedance